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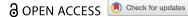
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Surface hydrogeneration of vanadium dioxide nanobeam to manipulate insulator-to-metal transition using hydrogen plasma

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ABSTRACT

This report suggests the process of hydrogen doping in vanadium dioxide (VO₂) nanobeam using hydrogen plasma, and in turn reveals the modification in the structural, chemical, physical, and electrical properties of VO₂ nanobeam that are associated with the different doping concentration. All V₂O₅ films were grown by spin-coating followed by heat treatment for the fabrication of VO₂ nanobeams. Further, the hydrogen is doped using reactive ion etching process and concentration of hydrogen in VO₂ is controlled by power and exposure time of ion etching. The hydrogen plasma-treated VO₂ nanobeams exhibits an additional triclinic (T) phase in comparison to monoclinic (M1) phase (observed in the pristine) and shows a decrease in the ratio of V^{4+} ions and forming V^{x+} ions (2 $\leq x \leq$ 3). In addition, the measured work function of the VO₂ nanobeams decreases with increasing hydrogen doping concentration. Further, the conductivity shows increasing behavior with increasing power (etching time) for a fixed etching time (power) at room temperature and the insulator-tometal transition (IMT) temperature was found to be decrease to ~ 306 K. This study demonstrates the fine-tuning of IMT temperature just by controlling the doping concentration of hydrogen on the surface of VO₂ nanobeam at 300 K.

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KEYWORDS

Hydrogen doping; vanadium dioxide; nanorods; insulatormetal transition temperature; Kelvin probe force microscopy

1. Introduction

The nature of the phase transition in strongly correlated metal oxides (e.g. transition metal oxides) opens new possibilities for various kind of applications such as energy storage, memory storage, switching, etc. [1]. Among various metal oxides, vanadium dioxide (VO₂) is of particular interest because of a variety of conceivable applications based on its ultrafast metal-toinsulator transition (MIT) [2-7]. Vanadium dioxide undergoes a first-order transition from a highresistivity semiconductor monoclinic (M1) phase to a metallic rutile (R) phase and exhibits an effective change in electrical resistivity of the third to fourth order within a narrow temperature range [3,8-11]. This change in electrical properties is accompanied by a significant optical transition in the infrared (IR) region that exhibits thermochromic action [6,7,11–16]. The mechanism by which MIT occurs in VO₂ is still a debatable topic, although MIT in the VO₂ is generally driven by the strong electron-electron correlations associated with Mott transitions or the electron-phonon interactions associated with Peierls transitions. Consequently, much effort has been made to understand the external strain, stoichiometry, interfacial stress, and the essential effect of doping on the IMT of VO₂ [8-10, 16-19].

In recent years, hydrogen doping has been widely used to control the carrier concentration, electrical, and optical properties of materials [20-29]. Hydrogen acts as a powerful electron donor and, unlike other metal dopants, has a very small atomic radius, so that large distortion of the crystal lattice does not occur during the doping of hydrogen atoms in the parent materials. Therefore, excessive formation of defects, which are uncontrollable and causing degradation of MIT property, can be avoided. Thus, hydrogenation can be used in a controlled manner to manipulate electronic structures in transition metal oxides (TMO) and chalcogenide compounds to enhance their applications [30-33]. For example, Wei et al. have used catalytic spillover to maintain the metal state of VO₂ [22]. An Au film was evaporated from one end of the VO₂ single crystal nanobeam and then heated in a hydrogen atmosphere. Under these conditions, the Au film worked as a catalyst and the hydrogen molecules were decomposed into H atoms at the surface of the Au thin film under heating, and then H atoms were doped into the VO₂ nanobeam. In addition, it is demonstrated that the MIT temperature could be significantly altered by reversible doping of H atoms via low-temperature annealing using the catalytic spillover process [22]. Furthermore, Hong et al. have suggested the morphotropic phase transformation in

single-crystalline VO₂ nanobeams caused by thermal reduction in a hydrogen environment [23]. They demonstrated that the reduced VO₂ nanobeams have a non-stoichiometric composition and its lower work function exhibit a hexagonal closed packing structure, and that these properties can be correlated to the creation of the oxygen-deficiency-related defects formed in the VO₂ nanobeams during the reduction process.

In the present study, we have optimized H doping conditions and fabricated H doped-VO₂ nanobeams for the fine tuning of insulator-to-metal transition temperature in a controlled manner. In addition, the effects of H doping on the electrical and structural properties of VO₂ nanobeams are studied. Unlike H-doping by thermal and spillover methods, plasma H-doping has the advantage of direct doping of the reactive H⁺ ions and H atoms at lower temperature with a fine control of the doping concentration by controlling plasma power and reaction time. Along with the optimized H-doping condition, we carefully characterized structural change, IMT temperature and chemical-/physical-/electronicmanipulation, property alterations of H-doped VO₂ nanobeams. This study provides a pathway for H-doping in the VO₂ nanobeam or thin films using the plasma method will be applicable for the progression of fine control of the temperature of the IMT for future optoelectronic devices.

2. Experimental

For the VO₂ nano-beam growth, thermally grown 285nm SiO₂ on p-type Si wafers were used as a substrate, which was pre-cleaned in acetone, isopropyl alcohol (IPA), and deionized water (DI) in sequence by sonication for 5 min and dried with nitrogen. To prepare the VO₂ growth source, initially, 1 g of vanadium oxide (V₂ O₅) powder (Sigma-Aldrich, Germany) was put into 20 ml of ethanol solution and then stirred at 300 K for at least 5 h. As a next step, the prepared V_2O_5 dispersion solution (3 ml) was dropped on the substrate and spin-coated at a rate of 1000 rpm. Then, the substrate coated with V₂O₅ solution was put on the hot plate and baked softly to remove ethanol at 340 K for a minute. Thermal chemical vapor deposition (TCVD) system (Sci&Tech Co. Ltd., Korea) was used for fabrication of VO₂ nanobeams using prepared V₂O₅ powder sources. After the sample was introduced into the center of quartz tube of TCVD, the base pressure was kept at below 1 mTorr. Next, argon gas was injected in the chamber with a flow rate of 10 sccm to maintain the working pressure of 1 Torr. In addition, the growth temperature was maintained at 850°C for 2 h. After the process, the quartz tube was cooled down at 300 K by moving the heater.

Further, the reactive ion etching (RIE) equipment (Sci&Tech Co. Ltd., Korea) was used for H doping in the VO₂ nanobeams. The RIE system was equipped with capacitive-coupled RF power and the chamber size was 400 mm in diameter and 50 mm in height. After introducing the samples, the chamber was vacuumed to less than 9 mTorr. Thereafter, hydrogen gas was inserted into the chamber with a flow rate of 50 sccm to maintain the working pressure of 0.2 mTorr. The plasma power and etching time were varied from 10 to 100 W and 1 to 10 min, respectively, to investigate their impact on the properties of VO₂ nanobeams as summarized in Table 1.

To measure the electrical characteristics of the nanobeams, electrical contacts were formed by the liftoff method as follows. First, hexamethyldisilane (HDMS) and 2 µm-thick photoresist (PR) was deposited on a nanobeam-deposited sample using a spin-coater. Thereafter, using a photomask and a mask-aligner, the light of the i-line wavelength band was irradiated by 80 mJ. After soft bake, the PR in the region where the electrode pads were deposited was removed by dipping it in the developing solution. Using an electronbeam (e-beam) evaporator, 3-nm-thick titanium and 50-nm-thick gold layers were deposited on the pad for metal contacts. Finally, the remaining PR was removed using acetone. A semiconductor parameter analyzer (Keithley 4200-SCS, USA) was used to measure the electrical properties in a pressure-controllable chamber equipped with probe station. The gold/ chrome electrical probe was used as a top electrode. For the temperature-dependent current-voltage measurements, a heater connected with the sample stage was used. Optical microscopy (Olympus BX51M, Japan) and field-emission scanning electron microscopy (Hitachi S-4800, Japan) were used to confirm the distribution, size, and shape of the nanobeams.

X-ray diffractometer (Rigaku Utima III, Japan) was utilized to identify the crystal structure of the samples. In addition, transmission electron microscopy (TEM) measurements were carried out using a JEOL JEM-2100 F (USA) instrument. Selected area electron diffraction (SAED) and fast Fourier transform (FFT) were used to confirm the crystallographic plane of a films. Energydispersive X-ray spectroscopy (EDS) was used for the elemental analysis of the nanobeams. Further, to

Table 1. Plasma parameters in H₂ RIE doping method. Upon varying plasma-treatment time, plasma power was fixed at 50 W. Upon changing RF power, the plasma exposure time was fixed at 5 min.

Pressure (Torr)	Time (min)	RF Power (W)				
0.2	0	-	-	50	-	-
	1	-	-	50	-	-
Flow rate (sccm)	5	10	20	50	80	100
50	10	-	-	50	-	-

analyze the electronic structure of the nanobeams, X-ray photoelectron spectroscopy (XPS; Thermo Fisher Scientific Co., USA) was used. The work function of VO₂ nanobeams was measured by performing the Kelvin probe force microscopy (KPFM) measurements using an ex-situ atomic force microscope (NT-MDT) with conductive Pt/Ir-coated Si tip (AC240-TM), having stiffness ~0.2 Nm⁻¹, diameter ~20 nm, and resonance frequency 74 kHz. The time of flight-secondary ion mass spectrometry (ToF-SIMS) (ION-TOF, Germany) was used to determine the hydrogen doping depth profiles in the VO₂ nanobeams.

3. Results and discussion

3.1. Growth mechanism and morphology

The VO₂ nanobeams are prepared from V₂O₅ powder in a thermal chemical vapor deposition (TCVD) system, as discussed in the experimental section. The device fabrication process and schematic of final device are shown in Figure 1(a). The as-deposited VO₂ nanobeams are found to be crystalline in nature and have monoclinic phase, as confirmed by X-ray diffraction (XRD) and Raman spectra (Figure 2 and see supplementary Figure S1). In addition, the optical image of VO₂ nanobeams grown on 285 nm thick SiO₂ covered Si substrate is shown in Figure 1(b), confirming longitudinal growth of nanobeams in the random direction. Further, the SEM image confirms the uniform width and random distributions of the VO₂ nanobeams as

their particular shape (Figure well as Interestingly, it is found that the length and width of the nanobeams are in the range of 50-100 µm and ~10 µm, respectively. Kindly note that one dimensional (i.e. height) of the nanobeams is in the range of 200 ~ 300 nm, and thus, it lies in the category of the nanosize. Based on that we judged that the expression nanobeam is appropriate to express the nanoscale in the height direction and the microscale in the length direction (Figure 1(c)). Further, for the elemental analysis, TEM-based EDS maps are carried out. Figure S2 depicts each elemental distribution of the vanadium (V), oxygen (O), and silicon (Si), respectively in different color maps. These EDS maps confirm the uniform distribution of all elements in the nanobeam along with its surface morphology.

3.2. Optimization of hydrogen plasma treatment factor

3.2.1. Crystal structure

It is considered that the crystallinity of films strongly depends on the doping concentration. Therefore, XRD spectra of VO₂ nanobeams before and after plasma treatment with different power and etching time are shown in Figure 2(a) and (b), respectively. It is observed that before plasma treatment, the (011) and (022) peaks appear at 28° and 57.7°, respectively, which are corresponding to the M1 phase of VO₂. On the other hand, after H doping, the appearance of subpeaks at

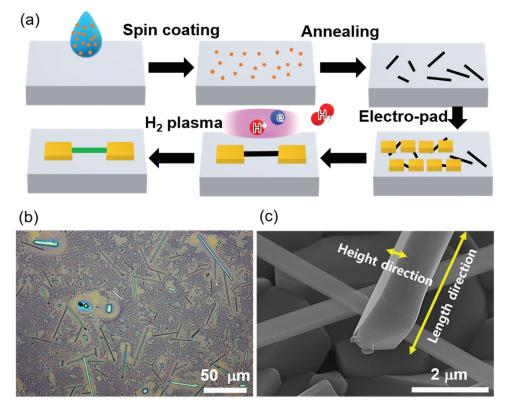


Figure 1. (a) Schematic illustration of VO₂ nanobeam device preparation process. (b) Optical microscope image of pristine VO₂ nanobeam. (c) SEM image of VO₂ nanobeam displaying typical rectangular shapes.

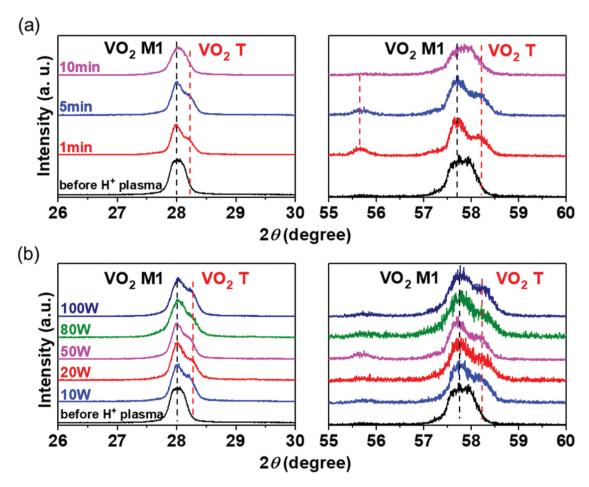


Figure 2. X-ray diffraction patterns for VO₂ nanobeam on SiO₂ substrate under (a) different etching time at fixed RF power and (b) different RF power at fixed etching time.

28.3° and 58.2° are observed with reduced full-widthhalf-maximum (FWHM) of the (011) peak for all used powers and for 1-5 min etching time. However, for 10 min etching time, the obtained XRD spectrum is found to be same as pristine sample (Figure 2(a)). It is well known that nanobeams grown in the [100] direction on a quartz substrate or an oxidized silicon substrate have a preferential orientation along (011) [22,34]. In the present case, the XRD results match well with the previous reports. In addition, no other impurities peak (for both the conditions) is observed [35] (see supplementary Figures S3 and S4). The formation of the subpeak, which seems to be derived from (011) peak, can be due to a decrease in the local (011) plane distance according to the Bragg equation. The reason behind this may be the presence of tensile stress to [100] direction and instantly compressive stress to (011) plane in the films due to H doping, which is further confirmed by Raman spectra (see supplementary Figure S1). It is reported that the Al and H doping in VO₂ nanobeam can introduce lattice strain due to incomplete doping and can form the triclinic (T) and/or M2 phase [22,36]. Although, in the present case, the (201) peak situated at 28.3° belongs to the T phase because in the case of the M2 phase, the

(201) and (201) peaks appear simultaneously [37]. Thus, it is concluded that the formation of the subpeak is correspond to the T phase.

3.2.2. Electrical properties

Figure 3 represents the change in electrical properties of the VO₂ nanobeam with H-plasma-treatment. To study the influence of processing time and RF power on the conductivity of VO2 nanobeams, ratio of conductivity increase (RCI) is calculated and compared, as shown in Figure 3(a) and b. It is interesting to note that the RCI increases from 5 to 45 with increasing RF power. With increasing RF plasma power, the reactive H⁺ and atomic H density increase which are supplied by the active dissociation in the H₂ plasma. Thus, the high RF power will affect (i) the diffusion amount of the reactive H⁺ and atomic H species from the plasma to the VO₂ nanobeams, (ii) the surface/bulk reaction of the VO₂ nanobeams associated with the adsorption and lattice bonding of hydrogen, and (iii) the lattice distortion or stress following the increase of H-doping amount. In addition, it is well known that a high intensity of plasma exposure with high RF power typically causes degradation of solid surface due to creation of oxygen vacancy and lattice distortion. On the other

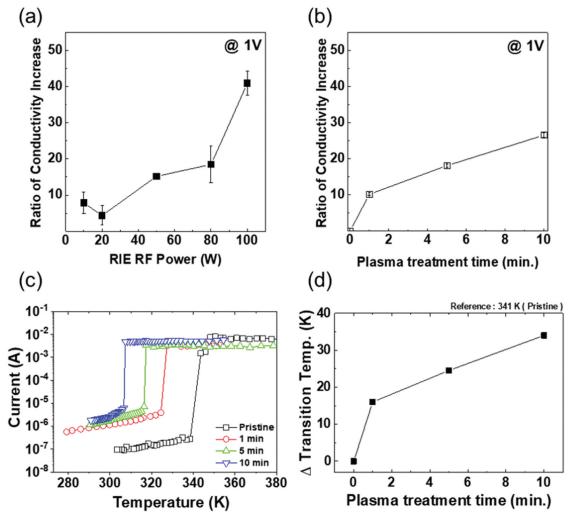


Figure 3. (a) The ratio of conductivity increase (RCI) dependent on RF power with fixed time at 5 min, and treatment time with fixed RF power at 50 W. (b) Temperature dependent current change of VO₂ nanobeam at 1 V. (c) Transition temperature difference with plasma processing time in current vs. temperature plot. (d) IMT temperature change vs. plasma treatment time.

hand, after hydrogen plasma treatment with different processing time, a relatively low deviation of 5% and a linear increase of RCI is observed, as depicted in Figure 3(b). Further, it is observed that at relatively low RF power (50 W), the steady-state condition of the diffusion and reaction of [as discussed above named (i)-(iii)] H doping at the near-surface of VO₂ nanobeam are mainly established up to depth of less than 10 nm (see supplementary Figure S6). In terms of device fabrication, it seems clearly that the processing time with fixed RF power of 50 W can be used for fine tuning the electrical properties of the VO₂ nanobeam by controlling H-doping concentration. Thus, for further electrical measurements of H-doped VO₂ nanobeams, the processing time and RF power of 5 min and 50 W are used as standard conditions. In addition, overall, the current level of all samples is increased by 10 ~ 10³ after hydrogen doping under the plasma treatment conditions (see supplementary Figure S5).

Figure 3(c) and (d) shows the change in current in the VO_2 nanobeam with temperature and the degree of change in transition temperature relative to the

pristine, respectively. It is noted that the current level at insulating state increases (as shown in Figure 3(a) and (b)) and the IMT temperature also decreases proportionally to hydrogen doping time. On the other hand, the ratio of the current level at the conducting state over the insulating state is observed at $10^4 \sim 10^5$ (as calculated from Figure 3(c)) in pristine (as calculated from Figure 3(c)) but reduced to $\sim 10^3$ after H doping. These results definitively confirm that H doping by plasma method also modifies IMT characteristics of VO₂ nanobeams as found in thermal H incorporation [22].

3.3. Mechanism for fine tuning on the surface of VO_2 nanobeam

3.3.1. X-ray photoelectron spectroscopy

Figure 4(a) and (b) shows the narrow scan XPS spectra of VO_2 nanobeams before and after H plasma treatment, respectively. The high resolution XPS spectra of V exhibits two main peaks in the range of 510–526 eV

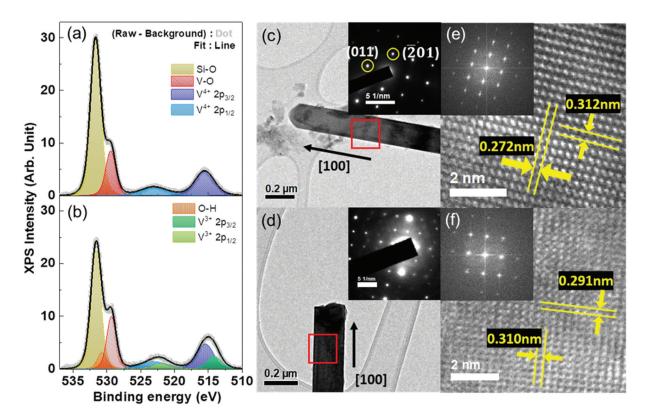


Figure 4. X-ray photoelectron spectrum and low-magnification bright-field TEM images; (a),(c), and (e) for pristine VO₂ and (b), (d), and (f) for 10 min hydrogen plasma treated VO₂ nanobeams. The corresponding SAED patterns are shown in the inset of each image. The zone axes are $[1\bar{2}2]$ for pristine VO₂ nanobeam. HRTEM images obtained near the edge (marked by squares) of the (e) pristine and (f) H-doped VO₂ nanobeams. The FFT patterns of each HRTEM image are shown in the insets.

of binding energy and no other impurity peak is observed. In the case of pristine VO₂ nanobeams, these two peaks are attributed to V $2p_{3/2}$ and V $2p_{1/2}$ at 515.5 and 523.1 eV, respectively (Figure 4(a)), which typically belong to V⁴⁺ state of VO₂. In addition, two distinct peaks in O 1s are observed at 529.4 and 531.7 eV, corresponding to V-O and Si-O (from substrate), respectively [34,38,39]. Due to spin-orbit coupling, the binding energy difference between V $2p_{3/2}$ and V $2p_{1/2}$ is found to be 7.6 eV as in previous reports [40]. On the other hand, in the V 2p narrow spectra of the hydrogen plasma-treated VO₂ nanobeam for 10 min (Figure 4(b)), the overall binding energy is shifted toward the lower value. In addition, upon the peak decomposition with gaussian fitting, additional peaks of V^{x+} corresponding to $2p_{3/2}$ and $2p_{1/2}$ are confirmed at the binding energy of 514.1 and 522.01 eV, respectively, suggesting a presence of mixed reduced phase $(2 \le x \le 3)$ [38,39]. Also, in the O 1s spectra, O-H peak is existed at 530.74 eV, excepting for the same Si-O and V-O peaks [22,34]. The binding energy difference between $V^x + 2p_{1/2}$ and $2p_{3/2}$ due to orbital splitting is 7.91 eV. Interestingly, in heavy metals doping such as W and Mo or thermal H-doping by spillover, which have been studied to control the IMT temperature of VO₂, there was no significant change in V 2p binding state [22,41]. However, from other studies, for example, Bermudez et al. have proposed a chemical reduction on the

surface of VO₂ by atomic hydrogen and reported similar kind of results in the case of hydrogen atom exposure to WO₃ (001) [42]. Subsequently, the same suggestion on O-H bond appearance in hydrogenated VO₂ was also reported [23,28,29]. These findings suggest that the reduction ratio of V^{4+} to V^{x} + can be directly related to V-OH bond formation. In our plasma treatment process, there were two kinds of reduction agent; the reactive H⁺ and atom H. Especially, when active H⁺ reacts with oxygen on the surface of VO₂ lattice, reduced vanadium valence can be easily formed. Also, when hydrogen atoms diffuse inside the lattice, as confirmed from XRD and Raman studies, V-O bond might be weakened by O-H, leading to a back-donation of valence electrons to V from O.

3.3.2 Transmission electron microscopy

Figure 4(c) and (d) represents the bright-field TEM images of the pristine VO₂ and 10-min H₂-plasmatreated VO₂ nanobeams, respectively. These images confirm the uniformity of the width of nanobeams. In addition, the high-resolution TEM images of both samples, before and after H plasma treatment, are obtained near the edge [indicated by red squares in (Figure 4(b) and (c)) of the VO₂ nanobeams, as shown in Figure 4(e) and (f). These verifies that the nanobeams are single-crystalline and demonstrate the monoclinic crystal structure. For the pristine VO₂ nanobeam, the lattice spacings of the adjacent (011) and (201) planes are approximately 0.312 and 0.272 nm, respectively (Figure 4(c)) [35]. On the other hand, for the H-doped VO₂ nanobeams, the lattice spacings of the neighboring (011) and ($\bar{2}01$) planes are approximately 0.310 and 0.291 nm (Figure 4(f)), respectively. In addition, the change in the (011) plane distance (from 0.312 to 0.310 nm) corresponds to strain as also observed from the spectral shift to higher angles in the XRD results (Figure 2). However, for $(\bar{2}01)$ plane, the change in the distance is negligible at 0.019 nm. Further, the insets in Figure 4(c-f) show the corresponding selected area electron diffraction (SAED) patterns of the TEM images for VO₂ nanobeams. The SAED pattern of the pristine VO₂ nanobeam (inset of Figure 4 (c)), considered along the $[1\bar{2}2]$ zone axis, indicates a single-crystalline monoclinic structure with growth direction along [100]. On the other hand, the hydrogen-plasma-treated VO₂ nanobeams show that the nanobeams have an irregular SAED pattern suggesting distorted crystalline structure caused by H incorporation into the VO₂ lattice. These measurements are in good agreement with the HRTEM results shown in the insets of panels (Figure 4(c) and (f)).

3.3.2. Kelvin probe force microscopy

In order to prove that hydrogen is incorporated to the surface, the KPFM measurements were performed which is very much surface sensitive technique. To reduce the variables owing to the size of the VO₂

nanobeams, similar width and height of topography for all measurements are selected and measured, as shown in Figure 5(a). Figure 5(b–d) shows the contact potential difference (CPD) maps corresponding to the pristine, 5 min, and 10 min H doping VO₂ samples, respectively. The contact potential difference is difference between the work function of the tip and the sample. Thus, one can calculate the work function of the sample using the following equation:

 $V_{\text{CPD}} = (\emptyset_{\text{tip}} - \emptyset_{\text{sample}})/e$, where \emptyset_{tip} is the work function of metal tip, $\emptyset_{\text{sample}}$ is the work function of a sample, and e is the electronic charge. The work function of the tip is calculated using a fresh cleaved highly oriented pyrolytic graphite (HOPG) sample. Figure 5(e) exhibits the calculated work function of VO₂ nanobeams for different hydrogen doping time. The work function of pristine VO₂ nanobeams is found to 5.39 eV, which is slightly higher than the reported value [23,43], and it decreases sequentially with increasing H-doping time. The lowest work function is found to be 5.29 eV for 10 min H doping time. From interpretation of the work function measured by KPFM from other recent studies, it has been found that the change in the work function is closely related to nearsurface stoichiometry (V/O ratio related to V valence) [23] or the density of point defect like oxygen vacancy in lattice [44]. In addition, the crystal structure is also considered a factor. For example, when the work

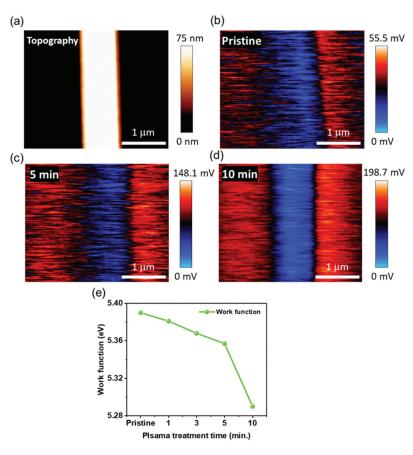


Figure 5. (a) Topography of pristine VO_2 nanobeam. (**b**–**d**) Kelvin probe force microscopy of hydrogen doped VO_2 nanobeam with each doping time conditions. (e) Work function deviation of the surface of VO_2 nanobeam with hydrogen doping time.

function of VO₂ nanobeam was measured in the temperature range of 300-375 K, it has been reported that the work function decreased by 0.14 eV through the transition of M1-T-M2 phase and found to be 5.16 eV in the rutile phase [45]. Among these various possible causes, based on the XPS data in Figure 4, the main factor of the decrease in work function of VO₂ nanobeam (in the present case) is the change in the valance state of V 2p core level toward lower binding energy (indicated as V^{x} +), which indicates the change in the near-surface stoichiometry. Also, formation of oxygen vacancies (V_O) , one of the products in the hydrogenation reactions that occurs before the construction of vanadium trivalent, can be a cause like following equa-

tion:
$$\frac{2H_{\textit{Surface}}^+ + 2e + 2O_{\textit{Surface}}^{2-} \rightarrow 2(\textit{OH})_{\textit{Surface}}^-}{\rightarrow H_2O + O_{\textit{Surface}}^{2-} + V_O} .$$
 However,

in the XPS results, it is necessary to review the existence of oxygen vacancies because of the similar binding energy between Si-O and oxygen vacancy in this study.

According to the results of metal-oxidehydrogenation studies, when hydrogen diffuses into metal oxide, the behavior of hydrogen in the oxides is found to be varying and depends on the location of the hydrogen in the lattice or the concentration of hydrogen [20,46]. This study is configured to form a steady-state hydrogen doping condition on the surface by controlling the processing time at limited RF power. Assuming that the H-doping amount increases linearly with time, when the doping amount is relatively small, a mixed phase of M1 and T is formed (as shown in Figure 2(a)) with tensile strain to [100] direction (as shown in Figure 4(b) and (e)), and at the same time, hydrogen can act as an electron donor on the surface to generate local V^x + (x:1 ~ 3). As doping time is increased, the surface hydrogen concentration also increases, and when the threshold exceeds, the OH bonding located at the near-surface will be relatively weakened to form oxygen vacancies and reducing oxidation state and the strain on the (011) was relaxed. In the XPS results, the effect of surface hydrogenation was confirmed through the reduced vanadium valence and OH peak (as shown in Figure 4(d)). Through these results, it was confirmed that the largest factor influencing the transition temperature was the amount of surface V^x+ generated by surface hydrogenation. In addition, the results from previous studies that the transition temperature decreases in linear proportion with the concentration of the reduced V phase supports the present study [13,47].

4. Conclusions

In conclusion, the effect of the hydrogen plasma doping process on the electrical properties and change in IMT temperature in the VO₂ single crystal nanobeam

are investigated. We successfully fabricated the H-doped VO₂ nanobeam by hydrogen plasma treatment in the RIE system at near 300 K. XPS studies confirm that the fractions of V⁴⁺ oxidation state in the VO₂ nanobeams is found to be decreased. The H-doped VO₂ nanobeam shows an M1 and T-mixed phase as observed from the XRD and TEM results. With respect to electrical characteristics, it is shown that the current level of the H-doped VO₂ nanobeam increases by three orders of magnitude compared to that of the pristine sample, and the degree of increase in current was proportional to the hydrogen plasma power and treatment time. Furthermore, the IMT temperature decreases in accordance with the H plasma doping time or total amount of H in VO₂. These results demonstrate that the hydrogen doping is successfully accomplished by hydrogen plasma treatment. A clear impact of H plasma doping in the reduction of vanadium oxidation state through hydrogenation over the surface of VO₂ nanobeam is observed, as confirmed from the surface work function of VO₂ nanobeam. Consequently, it is concluded that the decrease in IMT temperature is associated to amount of V^{x+} . Overall, these results pave an efficient and viable path for the regulation of IMT temperature and electrical conductivity of the VO₂ nanobeam using H plasma, which is essential for the practical application of Mott-based devices.

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Disclosure statement

No potential conflict of interest was reported by the author(s).

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Supporting information

Supplementary data to this article can be found online at . . .

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